



SPECIFICATIONS

Rated Current:1.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40℃ to +105℃

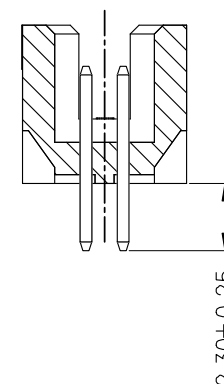
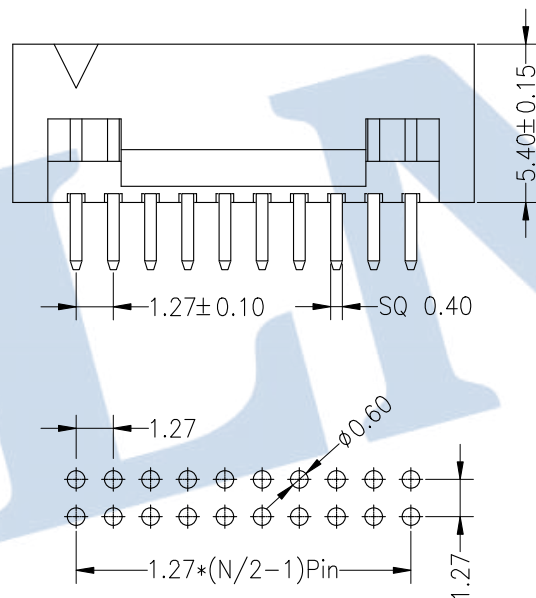
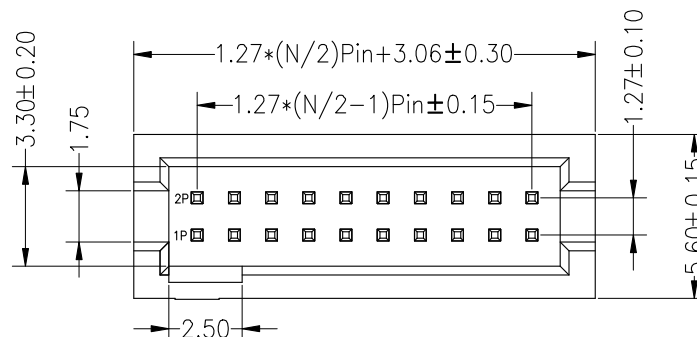
Contact Material:Brass

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Max.Processing Temp:

(PA6T/LCP/PA9T)260℃±5℃ For 5~10 Second



Ordering Information

3231 XX S XX X B K00 X XX

No.of Pins
NPin
N=10~100

Contact Plating

G0:Gold Flash

G1:1u" Gold

G2:1.5u" Gold

G3:2u" Gold

G4:3u" Gold

G5:5u" Gold

G6:10u" Gold

G7:15u" Gold

G8:30u" Gold

S0:Gold Flash/Tin

SN:Tin

Insulator Material

Option

C=BK-PA6T

E=BK-PA9T

F=BK-LCP

Packing

O=PE Bag

A=Tray

T=Tube

P=Tube+Cap

Stream Code

01~99

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

				OPERATION		DRAW	Jelly Feng	2023.05.13	SCALE	FIT	JiLN® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30				UNIT	mm		
				X.XX	±0.20	CHECK			SIZE	A4		
				X.XXX	±0.10							
A0	2023.05.13	NEW DRAWING		Angle	±3°	APPROVE			SHEET	1/1		
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL					PROJ.		TITLE: